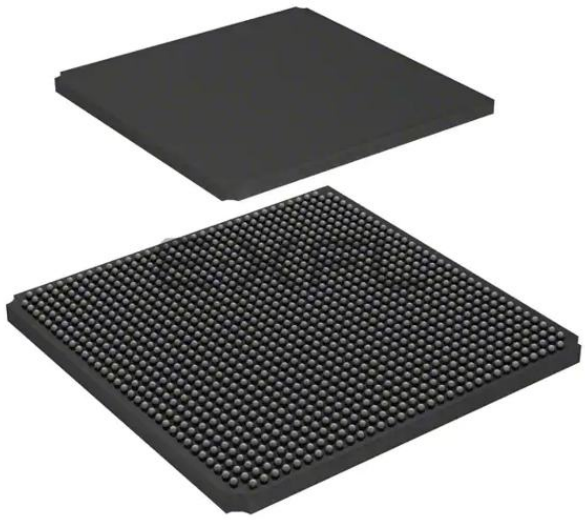
Lattice Semiconductor Corporation - LFSCM3GA80EP1-6FC1152I Datasheet



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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	20000
Number of Logic Elements/Cells	80000
Total RAM Bits	5816320
Number of I/O	660
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1152-BCBGA, FCBGA
Supplier Device Package	1152-CFCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfscm3ga80ep1-6fc1152i

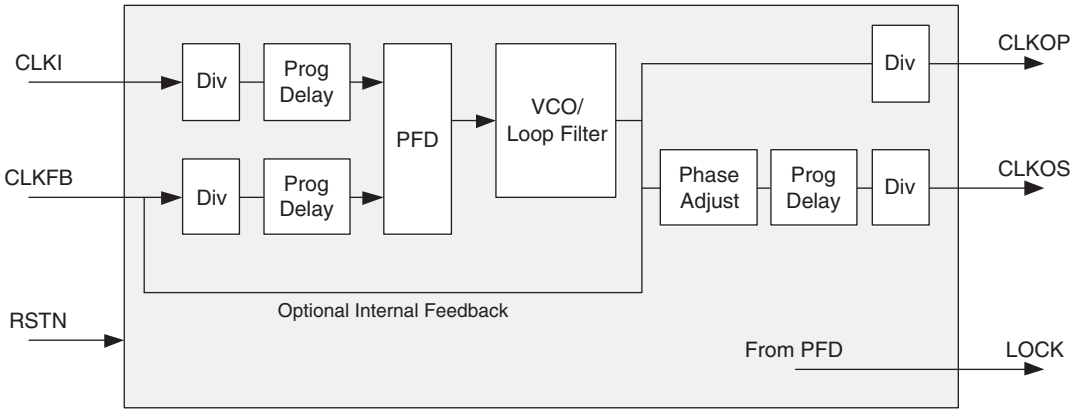
The setup and hold times of the device can be improved by programming a delay in the feedback or input path of the PLL which will advance or delay the output clock with reference to the input clock. This delay can be either programmed during configuration or can be adjusted dynamically.

The Phase Select block can modify the phase of the clock signal if desired. The Spread Spectrum block supports the modulation of the PLL output frequency. This reduces the peak energy in the fundamental and its harmonics providing for lower EMI (Electro Magnetic Interference).

The sysCLOCK PLL can be configured at power-up and then, if desired, reconfigured dynamically through the serial memory interface bus which connects with the on-chip system bus. For example, the user can select inputs, loop filters, divider setting, delay settings and phase shift settings. The user can also directly access the SMI bus through the routing.

The PLL clock input, from pin or routing, feeds into an input divider. There are four sources of feedback signal to the feedback divider: from the clock net, directly from the voltage controlled oscillator (VCO) output, from the routing or from an external pin. The signal from the input clock divider and the feedback divider are passed through the programmable delay before entering the phase frequency detector (PFD) unit. The output of this PFD is used to control the voltage controlled oscillator. There is a PLL_LOCK signal to indicate that VCO has locked on to the input clock signal. Figure 2-11 shows the sysCLOCK PLL diagram.

Figure 2-11. PLL Diagram



For more information on the PLL, please see details of additional technical documentation at the end of this data sheet.

Spread Spectrum Clocking (SSC)

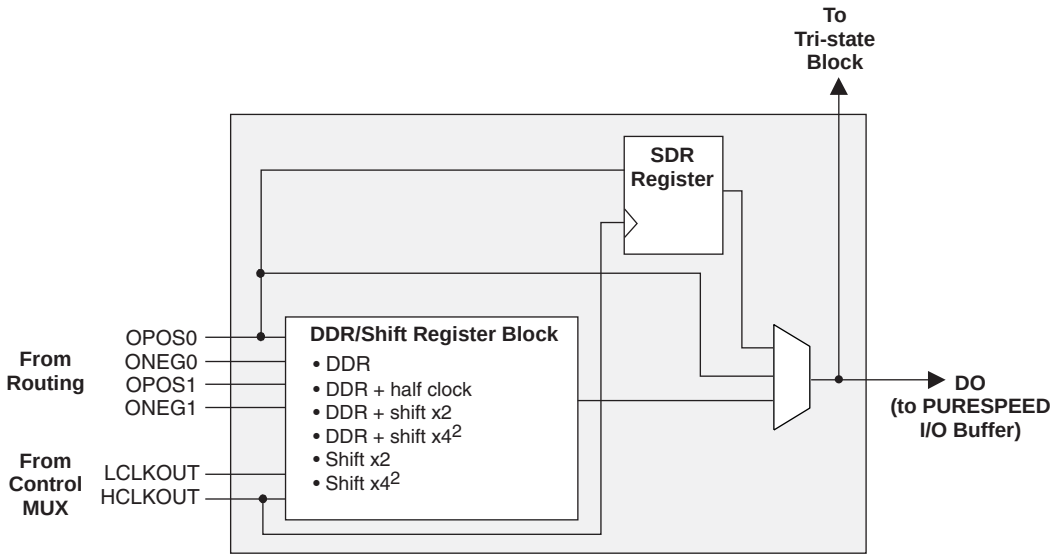
The PLL supports spread spectrum clocking to reduce peak EMI by using “down-spread” modulation. The spread spectrum operation will vary the output frequency (at 30KHz to 500KHz) in a range that is between its nominal value, down to a frequency that is a programmable 1%, 2%, or 3% lower than normal.

Digital Locked Loop (DLLs)

In addition to PLLs, the LatticeSC devices have up to 12 DLLs per device. DLLs assist in the management of clocks and strobes. DLLs are well suited to applications where the clock may be stopped or transferring jitter from input to output is important, for example forward clocked interfaces. PLLs are good for applications requiring the lowest output jitter or jitter filtering. All DLL outputs are routed as primary/edge clock sources.

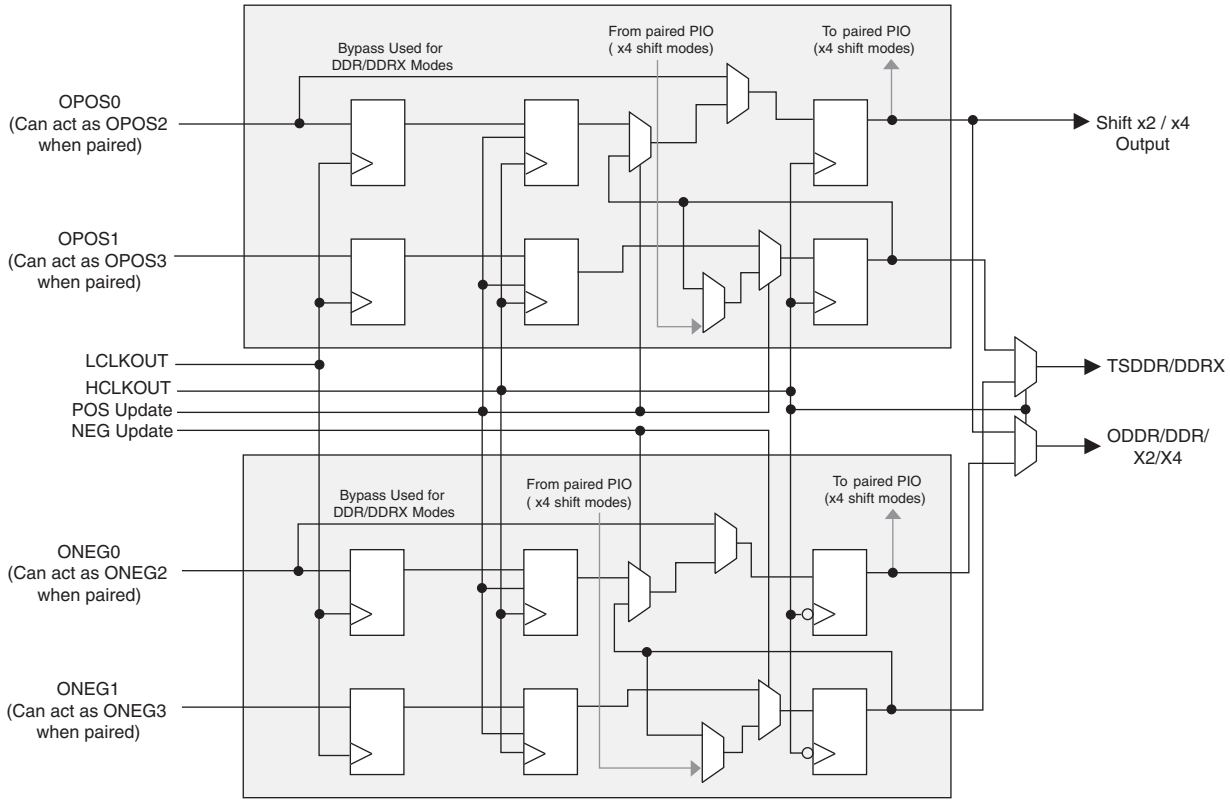
The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. LOCK output signal is asserted when the DLL is locked. The ALU HOLD signal setting allows users to freeze the DLL at its current delay setting.

Figure 2-22. Output Register Block[1]



Notes:
1. CE, Update, Set and Reset not shown for clarity.
2. By four shift modes utilizes DDR/Shift register block from paired PIO.
3. DDR/Shift register block shared with tristate block.

Figure 2-23. Output/Tristate DDR/Shift Register Block



Tristate Register Block

The tristate register block provides the ability to register tri-state control signals from the core of the device before they are passed to the PURESPEED I/O buffers. The block contains a register for SDR operation and a group of three registers for DDR and shift register operation. The output signal tri-state control signal (TO) can be derived directly from one of the inputs (bypass mode), the SDR shift register, the DDR registers or the data associated with the buffer (for open drain emulation). Figure 2-24 shows the diagram of the Tristate Register Block.

Tristate SDR Register/Latch Block

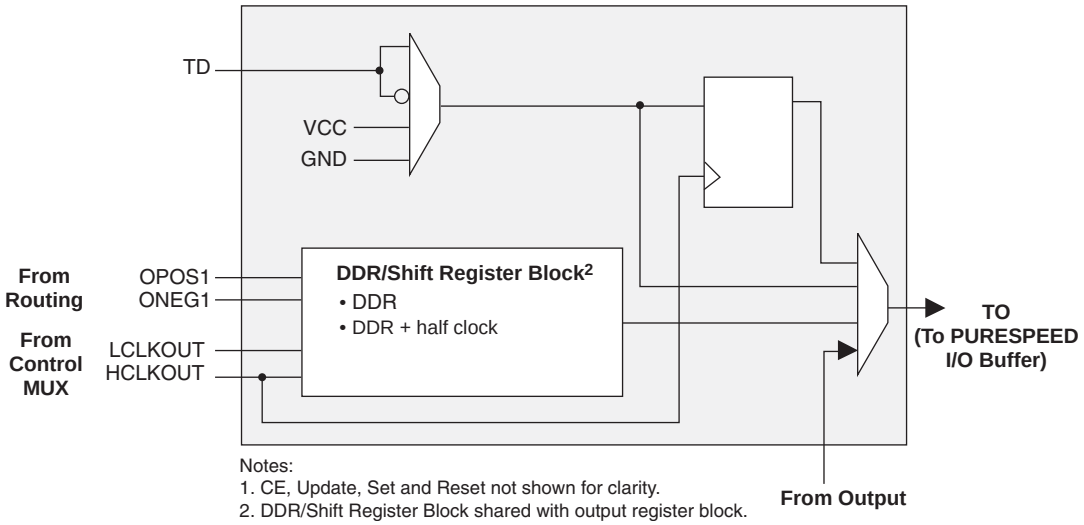
The SDR register operates on the positive edge of the high-speed clock. In it has a variety of programmable options for set/reset including, set or reset, asynchronous or synchronous Local Set Reset LSR and Global Set Reset GSR enable or disable. The register LSR input is driven from LSRO, which is generated from the PIO control MUX. The GSR input is driven from the GSR output of the PIO control MUX, which allows the global set-reset to be disabled on a PIO basis.

Tristate DDR/Shift Register Block

The DDR/Shift block is shared with the output block allowing DDR support using the high-speed clock and the associated transfer from the low-speed clock domain. It functions as a gearbox allowing low–speed parallel data from the FPGA fabric to provide a high-speed tri-state control stream.

There is a special mode for DDR-II memory interfaces where the termination is controlled by the output tristate signal. During WRITE cycle when the FPGA is driving the lines, the parallel terminations are turned off. During READ cycle when the FPGA is receiving data, the parallel terminations are turned on.

Figure 2-24. Tristate Register Block[1]



I/O Architecture Rules

Table 2-6 shows the PIO usage for x1, x2, x4 gearing. The checkmarks in the columns show the specific PIOs that are used for each gearing mode. When using x2 or x4 gearing, any PIO which is not used for gearing can still be used as an output.

- 8-bit SERDES Only
- 10-bit SERDES Only
- SONET (STS-12/STS-48)
- Gigabit Ethernet
- Fibre Channel
- XAUI
- Serial RapidIO
- PCI-Express
- Generic 8b10b

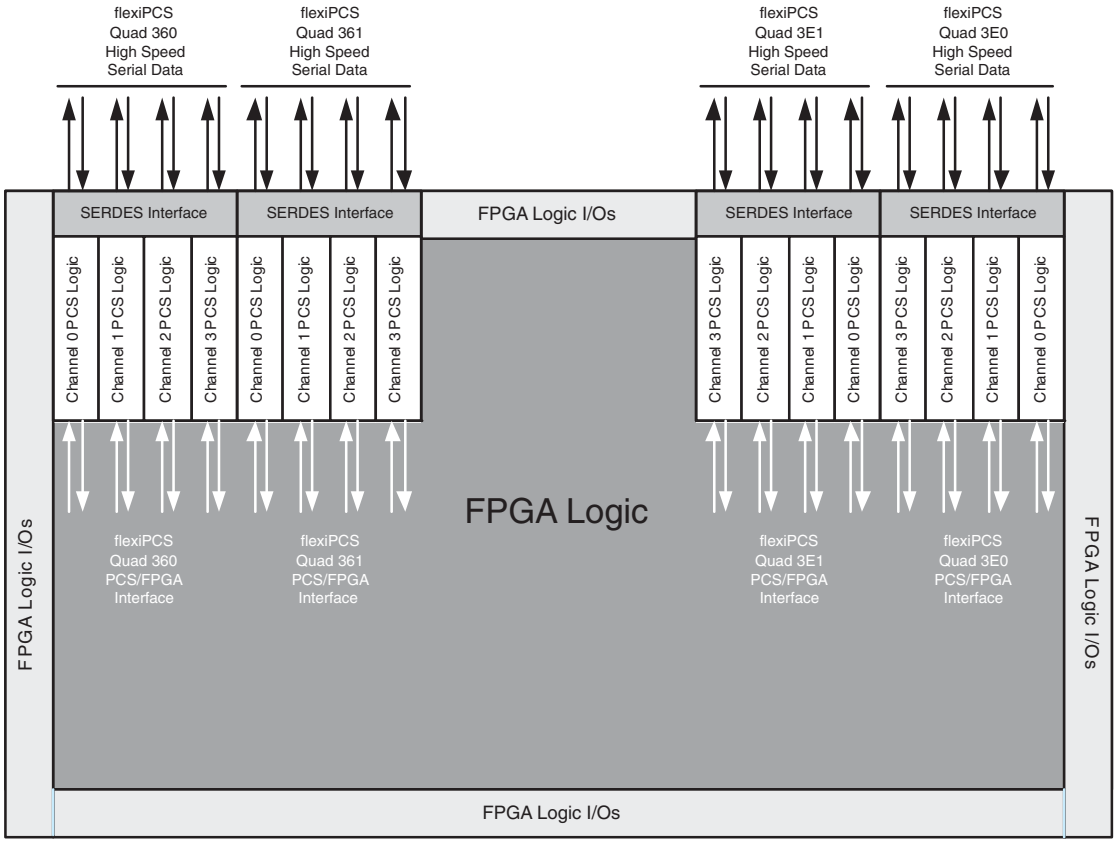
flexiPCS Quad

The flexiPCS logic is arranged in quads containing logic for four independent full-duplex data channels. Each device in the LatticeSC family has up to eight quads of flexiPCS logic. The LatticeSC Family Selection Guide table on the first page of this data sheet contains the number of flexiPCS channels present on the chip. Note that in some packages (particularly lower pin count packages), not all channels from all quads on a given device may be bonded to package pins.

Each quad supports up to four channels of full-duplex data and can be programmed into any one of several protocol based modes. Each quad requires its own reference clock which can be sourced externally or from the FPGA logic. The user can utilize between one and four channels in a quad, depending on the application.

Figure 2-30 shows an example of four flexiPCS quads in a LatticeSC device. Quads are labeled according to the address of their software controlled registers.

Figure 2-30. LatticeSC flexiPCS



Since each quad has its own reference clock, different quads can support different standards on the same chip. This feature makes the LatticeSC family of devices ideal for bridging between different standards.

Input Delay Block/AIL Timing

Parameter	Description	Min.	Typ.	Max.	Units
t_{FDEL}	Fine delay time	35	45	80	ps
t_{CDEL}	Coarse delay time	1120	1440	2560	ps
jt_{AIL}	AIL jitter tolerance	1- ((N^1 * t_{FDEL}) / (Clock Period))			UI

1. N = number of fine delays used in a particular AIL setting

GSR Timing

Parameter	Description	VCC	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
$t_{SYNC\_GSR\_MAX}$	Maximum operating frequency for synchronous GSR	1.14V	—	438	—	417	—	398	MHz
		0.95V	—	378	—	355	—	337	MHz
$t_{ASYNC\_GSR\_MPW}$	Minimum pulse width of asynchronous input	—	—	—	—	—	3.3	—	ns

Note: Synchronous GSR goes out of reset in two cycles from the clock edge where the setup time of the FF was met.

Internal System Bus Timing

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t_{HCLK}	Maximum operating frequency for internal system bus HCLK.	—	200	—	200	—	200	MHz

Note: There is no minimum frequency. If HCLK is sourced from the embedded oscillator, the minimum frequency limitation of the oscillator/ divider is about 0.3 MHz. Refer to the osciallator data for missing configuration modes.

Figure 3-8. Read Mode with Input and Output Registers

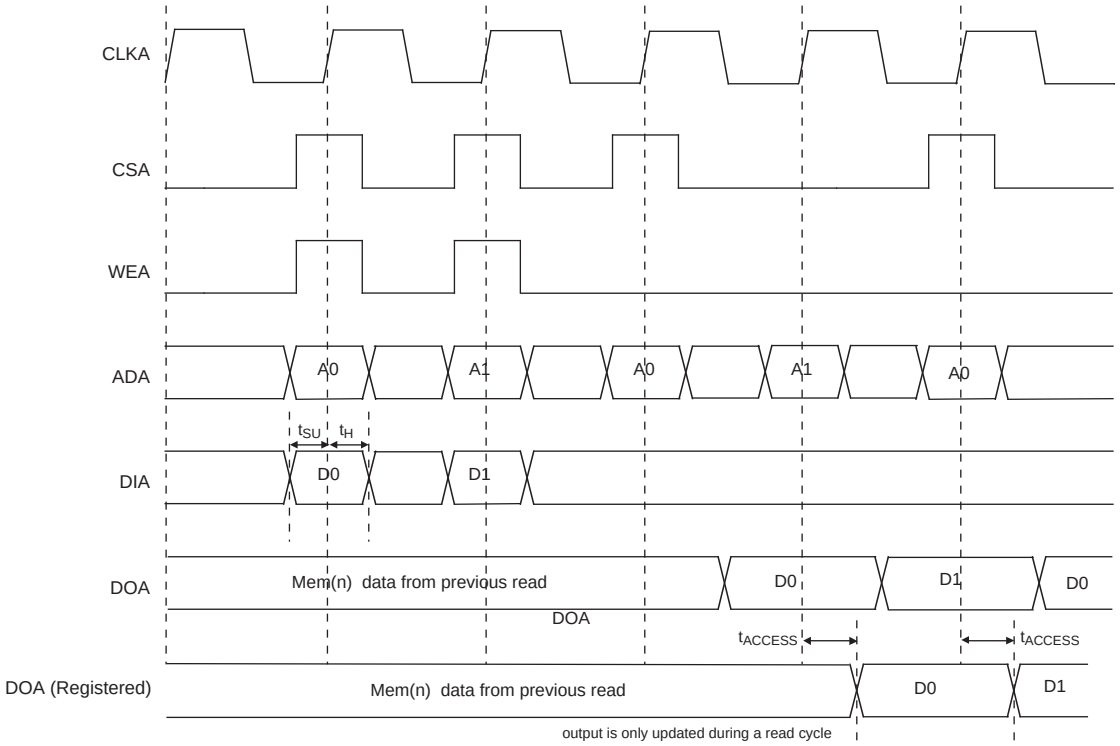
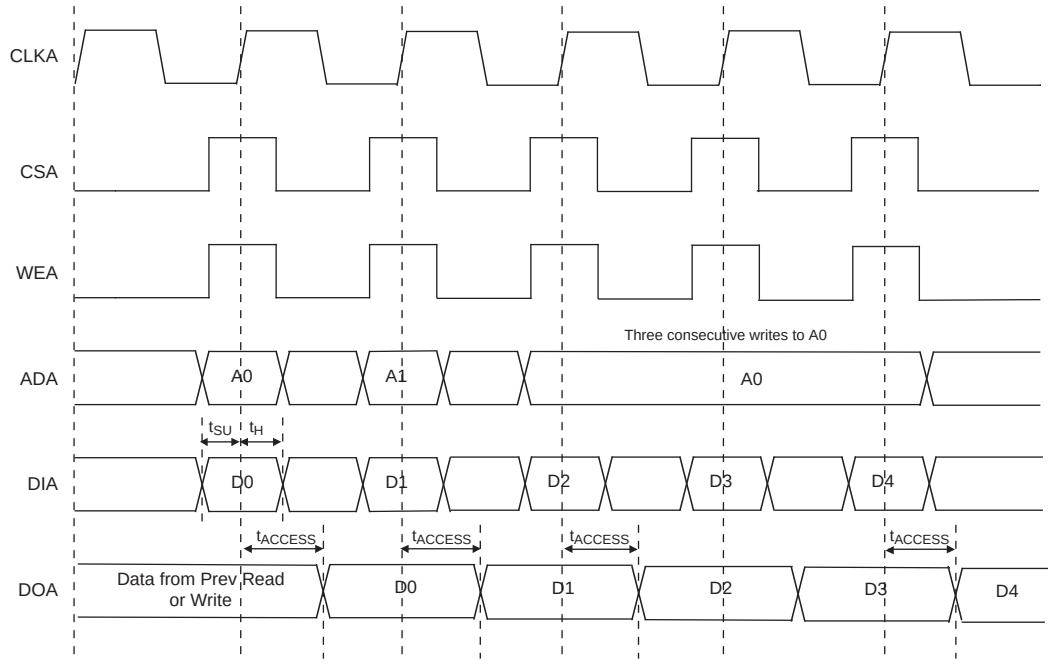


Figure 3-9. Write Through (SP Read/Write On Port A, Input Registers Only)



Note: Input data and address are registered at the positive edge of the clock and output data appears after the positive of the clock.

sysCLOCK DLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)		100	—	700	MHz
f_{OUTOP}	Output Clock Frequency (CLKOP)		100	—	700	MHz
f_{OUTOS}	Output Clock Frequency (CLKOS)		25	—	700	MHz
AC Characteristics						
t_{DUTY}	Output Clock Duty Cycle	Output Clock Duty Cycle (at 50% levels, 50% duty cycle input clock, duty cycle correction turned off, time reference delay mode)	38	—	62	%
t_{DUTYRD}	Output Clock Duty Cycle	Output Clock Duty Cycle (at 50% levels, arbitrary duty cycle input clock, duty cycle correction turned on, time reference delay mode)	45	—	55	%
$t_{DUTYCIR}$	Output Clock Duty Cycle	Output Clock Duty Cycle (at 50% levels, arbitrary duty cycle input clock, duty cycle correction turned on, clock injection removal mode)	40	—	60	%
t_{OPJIT}[1]	Output Clock Period Jitter		—	—	200	ps
t_{CPJIT}[1]	Output Clock Cycle-to-Cycle Jitter		—	—	200	ps
t_{SKEW}	Output Clock to Clock Skew (Between Two Outputs with the Same Phase Setting)		—	—	100	ps
t_{LOCK}	DLL Lock-in Time		8	—	18500	cycles
t_{IDUTY}	Input Clock Duty Cycle	Applies to all operating conditions	35	—	65	%
t_{IPJIT}	Input Clock Period Jitter		—	—	+/- 250	ps
t_{HI}	Input Clock High Time	At 80% level	500	—	—	ps
t_{LO}	Input Clock Low Time	At 20% level	500	—	—	ps
t_{RSWD}	Reset Signal Pulse Width		3	—	—	ns
t_{FDEL}	Timeshift Delay Step Size		35	45	80	ps
t_{DLL}	Delay Through the DLL when No Delay Taps are Chosen but Not in Bypass Mode.		—	760	—	ps

1. Values are measured with FPGA logic active, no additional I/Os toggling and REFCLK total jitter = 30 ps.

LatticeSC/M sysCONFIG Port Timing (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Asynchronous Peripheral Configuration Mode				
t_{WRAP}	WRN, CS0N and CS1 Pulse Width	5	-	ns
t_{SAP}	D[7:0] Setup Time	1.5	-	ns
t_{RDYAP}	RDY Delay	—	8	ns
t_{BAP}	RDY Low	1	8	CCLK periods
t_{WR2AP}	Earliest WRN After RDY Goes High	0	—	ns
t_{DENAP}	RDN to D[7:0] Enable/Disable	—	7.5	ns
t_{DAP}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Serial Configuration Mode				
t_{SSS}	DIN Setup Time	5.2	—	ns
t_{HSS}	DIN Hold Time	0	—	ns
t_{CHSS}	CCLK High Time	3.75	—	ns
t_{CLSS}	CCLK Low Time	3.75	—	ns
f_{CSS}	CCLK Frequency	—	150	MHz
t_{DSS}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Parallel Configuration Mode				
t_{S1SP}	CS0N, CS1, WRN Setup Time	5.2	—	ns
t_{H1SP}	CS0N, CS1, WRN Hold Time	0	—	ns
t_{S2SP}	D[7:0] Setup Time	5.2	—	ns
t_{H2SP}	D[7:0] Hold Time	0	—	ns
t_{CHSP}	CCLK High Time	3.75	—	ns
t_{CL}	CCLK Low Time	3.75	—	ns
f_{CSP}	CCLK Frequency	—	150	MHz

sysCONFIG MPI Port

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{MPICTRL\_SET}$	MPI Control (MPCSTRBN, MPCWRN, MPCCLK, etc.) to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
t_{MPIADR_SET}	MPI Address to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPIDAT_SET}	MPI Write Data to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
$t_{MPIDPAR\_SET}$	MPI Write Parity Data to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPI_HLD}	All Hold Times	0	—	0	—	0	—	ns
$t_{MPICTRL\_DEL}$	MPCCLK to MPI Control (MPCTA, MPC-TEA, MPCRETRY)	—	5.6	—	6.7	—	8.7	ns
t_{MPIDAT_DEL}	MPCCLK to MPI Data	—	5.6	—	6.7	—	8.7	ns
$t_{MPIDPAR\_DEL}$	MPCCLK to MPI Parity Data	—	4.9	—	5.7	—	7.7	ns
$f_{MPI\_CLK\_FRQ}$	MPCCLK Frequency	—	100	—	83	—	66	MHz

LFSC/M15 Logic Signal Connections: 256 fpBGA[1,2] (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
C5	A_VDDIB1_L	-	
A5	A_HDINP1_L	-	PCS 360 CH 1 IN P
B5	A_HDINN1_L	-	PCS 360 CH 1 IN N
A4	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
B4	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C4	A_VDDOB1_L	-	
B3	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
C3	A_VDDOB0_L	-	
A3	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
B2	A_HDINN0_L	-	PCS 360 CH 0 IN N
A2	A_HDINP0_L	-	PCS 360 CH 0 IN P
C2	A_VDDIB0_L	-	
A1	GND	-	
A16	GND	-	
B10	GND	-	
C13	GND	-	
D15	GND	-	
D3	GND	-	
E11	GND	-	
F13	GND	-	
G14	GND	-	
G2	GND	-	
G8	GND	-	
H10	GND	-	
J7	GND	-	
K15	GND	-	
K3	GND	-	
K9	GND	-	
M6	GND	-	
N11	GND	-	
N14	GND	-	
N2	GND	-	
P10	GND	-	
P4	GND	-	
R13	GND	-	
R7	GND	-	
G10	VCC	-	
G7	VCC	-	
G9	VCC	-	
H7	VCC	-	
H8	VCC	-	
H9	VCC	-	
J10	VCC	-	
J8	VCC	-	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AF4	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
AE5	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
AG3	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C
AH2	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C
AD6	PB4C	5		PB4C	5	
AJ2	PB5A	5		PB5A	5	
AK2	PB5B	5		PB5B	5	
AD7	PB5C	5		PB5C	5	
AD8	PB5D	5	VREF1_5	PB5D	5	VREF1_5
AH3	PB7A	5		PB11A	5	
AJ3	PB7B	5		PB11B	5	
AF9	PB7C	5		PB11C	5	
AE10	PB7D	5		PB11D	5	
AK3	PB8A	5		PB12A	5	
AJ4	PB8B	5		PB12B	5	
AE11	PB9A	5		PB13A	5	
AF10	PB9B	5		PB13B	5	
AK4	PB11A	5		PB16A	5	
AK5	PB11B	5		PB16B	5	
AH10	PB12A	5	PCLKT5_3	PB20A	5	PCLKT5_3
AH11	PB12B	5	PCLKC5_3	PB20B	5	PCLKC5_3
AF13	PB12C	5	PCLKT5_4	PB20C	5	PCLKT5_4
AE14	PB12D	5	PCLKC5_4	PB20D	5	PCLKC5_4
AK6	PB13A	5	PCLKT5_5	PB21A	5	PCLKT5_5
AK7	PB13B	5	PCLKC5_5	PB21B	5	PCLKC5_5
AF14	PB13C	5		PB21C	5	
AJ11	PB15A	5	PCLKT5_0	PB23A	5	PCLKT5_0
AJ12	PB15B	5	PCLKC5_0	PB23B	5	PCLKC5_0
AH13	PB15D	5	VREF2_5	PB23D	5	VREF2_5
AK8	PB16A	5	PCLKT5_1	PB24A	5	PCLKT5_1
AK9	PB16B	5	PCLKC5_1	PB24B	5	PCLKC5_1
AH14	PB17A	5	PCLKT5_2	PB25A	5	PCLKT5_2
AG14	PB17B	5	PCLKC5_2	PB25B	5	PCLKC5_2
AK10	PB19A	5		PB28A	5	
AK11	PB19B	5		PB28B	5	
AH15	PB20A	5		PB29A	5	
AG15	PB20B	5		PB29B	5	
AH12	PB21A	5		PB31A	5	
AJ13	PB21B	5		PB31B	5	
AD15	PB21C	5		PB31C	5	
AE15	PB21D	5		PB31D	5	
AK12	PB23A	5		PB32A	5	
AK13	PB23B	5		PB32B	5	
AJ14	PB24A	5		PB33A	5	
AJ15	PB24B	5		PB33B	5	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
D14	PT15B	1	A15/MPI_ADDR29	PT25B	1	A15/MPI_ADDR29
D13	PT15A	1	A17/MPI_ADDR31	PT25A	1	A17/MPI_ADDR31
F12	PT13D	1	A19/MPI_TSIZ1	PT24D	1	A19/MPI_TSIZ1
F13	PT13C	1	A20/MPI_BDIP	PT24C	1	A20/MPI_BDIP
B12	PT11B	1	A18/MPI_TSIZ0	PT24B	1	A18/MPI_TSIZ0
B11	PT11A	1	MPI_TEA	PT24A	1	MPI_TEA
E12	PT10D	1	D14/MPI_DATA14	PT23D	1	D14/MPI_DATA14
D12	PT10C	1	DP1/MPI_PAR1	PT23C	1	DP1/MPI_PAR1
G10	PT9B	1	A21/MPI_BURST	PT23B	1	A21/MPI_BURST
G9	PT9A	1	D15/MPI_DATA15	PT23A	1	D15/MPI_DATA15
C10	A_VDDIB3_L	-		A_VDDIB3_L	-	
E9	VCC12	-		VCC12	-	
B10	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A10	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
D9	VCC12	-		VCC12	-	
A9	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C9	A_VDDOB3_L	-		A_VDDOB3_L	-	
A8	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C8	A_VDDOB2_L	-		A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
E8	VCC12	-		VCC12	-	
B8	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
B7	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
C7	A_VDDIB2_L	-		A_VDDIB2_L	-	
D8	VCC12	-		VCC12	-	
C6	A_VDDIB1_L	-		A_VDDIB1_L	-	
E7	VCC12	-		VCC12	-	
B6	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
B5	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
A6	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
D7	VCC12	-		VCC12	-	
A5	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C5	A_VDDOB1_L	-		A_VDDOB1_L	-	
A4	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
C4	A_VDDOB0_L	-		A_VDDOB0_L	-	
A3	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
E6	VCC12	-		VCC12	-	
B4	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
B3	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
C3	A_VDDIB0_L	-		A_VDDIB0_L	-	
D6	VCC12	-		VCC12	-	
L5	NC	-		PL21A	7	
M5	NC	-		PL21B	7	
G2	NC	-		PL20A	7	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E22	VCC12	-		VCC12	-	
E21	VCC12	-		VCC12	-	
E3	VCC12	-		VCC12	-	
E4	VCC12	-		VCC12	-	
E6	VCC12	-		VCC12	-	
E7	VCC12	-		VCC12	-	
E8	VCC12	-		VCC12	-	
E9	VCC12	-		VCC12	-	
E11	VCC12	-		VCC12	-	
E12	VCC12	-		VCC12	-	
A23	GND	-		GND	-	
A31	GND	-		GND	-	
AA13	GND	-		GND	-	
AA15	GND	-		GND	-	
AA18	GND	-		GND	-	
AA20	GND	-		GND	-	
AA26	GND	-		GND	-	
AA6	GND	-		GND	-	
AB10	GND	-		GND	-	
AB24	GND	-		GND	-	
AC14	GND	-		GND	-	
AC22	GND	-		GND	-	
AC29	GND	-		GND	-	
AC3	GND	-		GND	-	
AD11	GND	-		GND	-	
AD19	GND	-		GND	-	
AD27	GND	-		GND	-	
AD7	GND	-		GND	-	
AF12	GND	-		GND	-	
AF18	GND	-		GND	-	
AF24	GND	-		GND	-	
AF30	GND	-		GND	-	
AF4	GND	-		GND	-	
AG15	GND	-		GND	-	
AG21	GND	-		GND	-	
AG9	GND	-		GND	-	
AJ10	GND	-		GND	-	
AJ16	GND	-		GND	-	
AJ20	GND	-		GND	-	
AJ26	GND	-		GND	-	
AJ29	GND	-		GND	-	
AJ4	GND	-		GND	-	
AK13	GND	-		GND	-	
AK17	GND	-		GND	-	
AK23	GND	-		GND	-	
AK7	GND	-		GND	-	
AL1	GND	-		GND	-	
AL32	GND	-		GND	-	
AM2	GND	-		GND	-	
AM31	GND	-		GND	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AN33	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B
AH29	PB3C	5	LLC_DLLT_IN_C/LLC_DLLT_FB_D
AJ29	PB3D	5	LLC_DLLC_IN_C/LLC_DLLC_FB_D
AM32	PB4A	5	LLC_DLLT_IN_D/LLC_DLLT_FB_C
AM31	PB4B	5	LLC_DLLC_IN_D/LLC_DLLC_FB_C
AG27	PB4C	5	
AG26	PB4D	5	
AL29	PB5A	5	
AL28	PB5B	5	
AH27	PB5C	5	
AH26	PB5D	5	VREF1_5
AN32	PB7A	5	
AP32	PB7B	5	
AF25	PB7C	5	
AE25	PB7D	5	
AN31	PB11A	5	
AN30	PB11B	5	
AK29	PB11C	5	
AK28	PB11D	5	
AP31	PB12A	5	
AP30	PB12B	5	
AD24	PB12C	5	
AE24	PB12D	5	
AM29	PB15A	5	
AM28	PB15B	5	
AJ27	PB15C	5	
AJ26	PB15D	5	
AP29	PB16A	5	
AP28	PB16B	5	
AK27	PB16C	5	
AK26	PB16D	5	
AN29	PB19A	5	
AN28	PB19B	5	
AG25	PB19C	5	
AG24	PB19D	5	
AL26	PB20A	5	
AL25	PB20B	5	
AG23	PB20C	5	
AG22	PB20D	5	
AN27	PB23A	5	
AN26	PB23B	5	
AF24	PB23C	5	
AF23	PB23D	5	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AD5	PR94C	3	
AE2	PR94B	3	
AD2	PR94A	3	
AC5	PR92D	3	
AB5	PR92C	3	
AF1	PR92B	3	
AE1	PR92A	3	
AA11	PR91D	3	
Y11	PR91C	3	
AC4	PR91B	3	
AB4	PR91A	3	
AA8	PR90D	3	DIFFR_3
AA9	PR90C	3	
AC3	PR90B	3	
AB3	PR90A	3	
AA7	PR79D	3	
Y7	PR79C	3	
AA2	PR79B	3	
Y2	PR79A	3	
AA6	PR77D	3	
Y6	PR77C	3	
Y4	PR77B	3	
W4	PR77A	3	
W11	PR74D	3	
V11	PR74C	3	
W2	PR74B	3	
V2	PR74A	3	
W9	PR71D	3	
V9	PR71C	3	
V1	PR71B	3	
U1	PR71A	3	
W10	PR70D	3	
V10	PR70C	3	
U2	PR70B	3	
T2	PR70A	3	
Y8	PR69D	3	
W8	PR69C	3	VREF1_3
W5	PR69B	3	
V5	PR69A	3	
V7	PR66D	3	PCLKC3_2
U7	PR66C	3	PCLKT3_2
T1	PR66B	3	
R1	PR66A	3	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
L21	PT55D	1	A16/MPI_ADDR30
L20	PT55C	1	D13/MPI_DATA13
D20	PT55B	1	A15/MPI_ADDR29
E20	PT55A	1	A17/MPI_ADDR31
L19	PT54D	1	A19/MPI_TSIZ1
K19	PT54C	1	A20/MPI_BDIP
D21	PT54B	1	A18/MPI_TSIZ0
E21	PT54A	1	MPI_TEA
M20	PT51D	1	D14/MPI_DATA14
M19	PT51C	1	DP1/MPI_PAR1
F21	PT51B	1	A21/MPI_BURST
G21	PT51A	1	D15/MPI_DATA15
H24	B_REFCLKP_L	-	
J24	B_REFCLKN_L	-	
L22	VCC12	-	
E26	B_VDDIB3_L	-	
G22	VCC12	-	
E22	B_HDINP3_L	-	PCS 361 CH 3 IN P
F22	B_HDINN3_L	-	PCS 361 CH 3 IN N
A21	B_HDOUTP3_L	-	PCS 361 CH 3 OUT P
L24	VCC12	-	
B21	B_HDOUTN3_L	-	PCS 361 CH 3 OUT N
D22	B_VDDOB3_L	-	
B22	B_HDOUTN2_L	-	PCS 361 CH 2 OUT N
D23	B_VDDOB2_L	-	
A22	B_HDOUTP2_L	-	PCS 361 CH 2 OUT P
K24	VCC12	-	
F23	B_HDINN2_L	-	PCS 361 CH 2 IN N
E23	B_HDINP2_L	-	PCS 361 CH 2 IN P
D26	B_VDDIB2_L	-	
G23	VCC12	-	
D27	B_VDDIB1_L	-	
G24	VCC12	-	
E24	B_HDINP1_L	-	PCS 361 CH 1 IN P
F24	B_HDINN1_L	-	PCS 361 CH 1 IN N
A23	B_HDOUTP1_L	-	PCS 361 CH 1 OUT P
L25	VCC12	-	
B23	B_HDOUTN1_L	-	PCS 361 CH 1 OUT N
D24	B_VDDOB1_L	-	
B24	B_HDOUTN0_L	-	PCS 361 CH 0 OUT N
D25	B_VDDOB0_L	-	
A24	B_HDOUTP0_L	-	PCS 361 CH 0 OUT P
K25	VCC12	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
R12	VTT_2	2	
T12	VTT_2	2	
AB11	VTT_3	3	
W12	VTT_3	3	
Y12	VTT_3	3	
AC15	VTT_4	4	
AC16	VTT_4	4	
AD13	VTT_4	4	
AC19	VTT_5	5	
AC20	VTT_5	5	
AD22	VTT_5	5	
AB24	VTT_6	6	
W23	VTT_6	6	
Y23	VTT_6	6	
N24	VTT_7	7	
R23	VTT_7	7	
T23	VTT_7	7	
M12	VDDAX25_R	-	
M23	VDDAX25_L	-	
Y16	GND	-	
Y14	GND	-	
N21	VCC12	-	
P22	VCC12	-	
AA22	VCC12	-	
AB21	VCC12	-	
AB14	VCC12	-	
AA13	VCC12	-	
P13	VCC12	-	
N14	VCC12	-	
G26	NC	-	
G9	NC	-	
J12	NC	-	
H12	NC	-	
H23	NC	-	
J23	NC	-	

1. Differential pair grouping within a PCI is A (True) and B (complement) and C (True) and D (Complement).
2. The LatticeSC/M115 in an 1152-pin package supports a 32-bit MPI interface.

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
A26	D_HDOUTN2_L	-	PCS 363 CH 2 OUT N	D_HDOUTN2_L	-	PCS 363 CH 2 OUT N
C34	D_VDDOB2_L	-		D_VDDOB2_L	-	
B26	D_HDOUTP2_L	-	PCS 363 CH 2 OUT P	D_HDOUTP2_L	-	PCS 363 CH 2 OUT P
C32	VCC12	-		VCC12	-	
E27	D_HDINN2_L	-	PCS 363 CH 2 IN N	D_HDINN2_L	-	PCS 363 CH 2 IN N
D27	D_HDINP2_L	-	PCS 363 CH 2 IN P	D_HDINP2_L	-	PCS 363 CH 2 IN P
G25	D_VDDIB2_L	-		D_VDDIB2_L	-	
F29	VCC12	-		VCC12	-	
H26	D_VDDIB1_L	-		D_VDDIB1_L	-	
F30	VCC12	-		VCC12	-	
D28	D_HDINP1_L	-	PCS 363 CH 1 IN P	D_HDINP1_L	-	PCS 363 CH 1 IN P
E28	D_HDINN1_L	-	PCS 363 CH 1 IN N	D_HDINN1_L	-	PCS 363 CH 1 IN N
B27	D_HDOUTP1_L	-	PCS 363 CH 1 OUT P	D_HDOUTP1_L	-	PCS 363 CH 1 OUT P
F36	VCC12	-		VCC12	-	
A27	D_HDOUTN1_L	-	PCS 363 CH 1 OUT N	D_HDOUTN1_L	-	PCS 363 CH 1 OUT N
F35	D_VDDOB1_L	-		D_VDDOB1_L	-	
A28	D_HDOUTN0_L	-	PCS 363 CH 0 OUT N	D_HDOUTN0_L	-	PCS 363 CH 0 OUT N
M30	D_VDDOB0_L	-		D_VDDOB0_L	-	
B28	D_HDOUTP0_L	-	PCS 363 CH 0 OUT P	D_HDOUTP0_L	-	PCS 363 CH 0 OUT P
F37	VCC12	-		VCC12	-	
E29	D_HDINN0_L	-	PCS 363 CH 0 IN N	D_HDINN0_L	-	PCS 363 CH 0 IN N
D29	D_HDINP0_L	-	PCS 363 CH 0 IN P	D_HDINP0_L	-	PCS 363 CH 0 IN P
H27	D_VDDIB0_L	-		D_VDDIB0_L	-	
G28	VCC12	-		VCC12	-	
J28	C_REFCLKP_L	-		C_REFCLKP_L	-	
K28	C_REFCLKN_L	-		C_REFCLKN_L	-	
F32	VCC12	-		VCC12	-	
G29	C_VDDIB3_L	-		C_VDDIB3_L	-	
C31	VCC12	-		VCC12	-	
D30	C_HDINP3_L	-	PCS 362 CH 3 IN P	C_HDINP3_L	-	PCS 362 CH 3 IN P
E30	C_HDINN3_L	-	PCS 362 CH 3 IN N	C_HDINN3_L	-	PCS 362 CH 3 IN N
B29	C_HDOUTP3_L	-	PCS 362 CH 3 OUT P	C_HDOUTP3_L	-	PCS 362 CH 3 OUT P
F38	VCC12	-		VCC12	-	
A29	C_HDOUTN3_L	-	PCS 362 CH 3 OUT N	C_HDOUTN3_L	-	PCS 362 CH 3 OUT N
J33	C_VDDOB3_L	-		C_VDDOB3_L	-	
A30	C_HDOUTN2_L	-	PCS 362 CH 2 OUT N	C_HDOUTN2_L	-	PCS 362 CH 2 OUT N
K33	C_VDDOB2_L	-		C_VDDOB2_L	-	
B30	C_HDOUTP2_L	-	PCS 362 CH 2 OUT P	C_HDOUTP2_L	-	PCS 362 CH 2 OUT P
J34	VCC12	-		VCC12	-	
F31	C_HDINN2_L	-	PCS 362 CH 2 IN N	C_HDINN2_L	-	PCS 362 CH 2 IN N
E31	C_HDINP2_L	-	PCS 362 CH 2 IN P	C_HDINP2_L	-	PCS 362 CH 2 IN P
G30	C_VDDIB2_L	-		C_VDDIB2_L	-	
H28	VCC12	-		VCC12	-	
C37	C_VDDIB1_L	-		C_VDDIB1_L	-	
H30	VCC12	-		VCC12	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH27	VCCAUX	-		VCCAUX	-	
AH29	VCCAUX	-		VCCAUX	-	
AJ14	VCCAUX	-		VCCAUX	-	
AJ15	VCCAUX	-		VCCAUX	-	
AJ28	VCCAUX	-		VCCAUX	-	
AJ29	VCCAUX	-		VCCAUX	-	
P14	VCCAUX	-		VCCAUX	-	
P15	VCCAUX	-		VCCAUX	-	
P28	VCCAUX	-		VCCAUX	-	
P29	VCCAUX	-		VCCAUX	-	
R14	VCCAUX	-		VCCAUX	-	
R16	VCCAUX	-		VCCAUX	-	
R17	VCCAUX	-		VCCAUX	-	
R18	VCCAUX	-		VCCAUX	-	
R19	VCCAUX	-		VCCAUX	-	
R20	VCCAUX	-		VCCAUX	-	
R23	VCCAUX	-		VCCAUX	-	
R24	VCCAUX	-		VCCAUX	-	
R25	VCCAUX	-		VCCAUX	-	
R26	VCCAUX	-		VCCAUX	-	
R27	VCCAUX	-		VCCAUX	-	
R29	VCCAUX	-		VCCAUX	-	
T15	VCCAUX	-		VCCAUX	-	
T28	VCCAUX	-		VCCAUX	-	
U15	VCCAUX	-		VCCAUX	-	
U28	VCCAUX	-		VCCAUX	-	
V15	VCCAUX	-		VCCAUX	-	
V28	VCCAUX	-		VCCAUX	-	
W15	VCCAUX	-		VCCAUX	-	
W28	VCCAUX	-		VCCAUX	-	
Y15	VCCAUX	-		VCCAUX	-	
Y28	VCCAUX	-		VCCAUX	-	
F3	VCCIO1	-		VCCIO1	-	
F39	VCCIO1	-		VCCIO1	-	
G35	VCCIO1	-		VCCIO1	-	
G8	VCCIO1	-		VCCIO1	-	
L19	VCCIO1	-		VCCIO1	-	
L24	VCCIO1	-		VCCIO1	-	
M16	VCCIO1	-		VCCIO1	-	
M27	VCCIO1	-		VCCIO1	-	
N11	VCCIO1	-		VCCIO1	-	
N32	VCCIO1	-		VCCIO1	-	
AA4	VCCIO2	-		VCCIO2	-	
H7	VCCIO2	-		VCCIO2	-	
J4	VCCIO2	-		VCCIO2	-	

Date	Version	Section	Change Summary
September 2007	01.7	Pinout Information	Added Thermal Management text section.
		Supplemental Information	Updated title list.
November 2007	01.8	Ordering Information	Removed -7 speed grade information for 115K LUT devices in the Ordering Information tables.
January 2008	01.9	Introduction	Corrections/Additions to memory controller list (Tables 1-2).
		Architecture	AIL Overview – Modified power used by AIL block.
			PURESPEED I/O Buffer Banks – Modified VTT termination info. Added info about complimentary drivers for all banks.
			Supported Source Synchronous Interfaces – Modified data for DDRII in Table 2-11.
		DC and Switching Characteristics	Recommended Operating Conditions – Changed footnote 3.
			Initialization and Standby Supply Current – Inserted a paragraph with info regarding the table. Also updated the table.
			Typical Building Block Function Performance – Added VCC=1.2V=1.2V+/-5% above Pin to Pin Performance table.
			LatticeSC External Switching Characteristics – Added VCC=1.2V=1.2V+/-5% above table. Reworded footnote 3.
			LatticeSC Family Timing Adders – Added VCC=1.2V=1.2V+/-5% above table.
			LatticeSC Internal Timing Parameters – Added VCC=1.2V=1.2V+/-5% above table. Reworded footnote 1.
			GSR Timing – Added a new table for Internal System Bus Timing after GSR Timing.
			LatticeSC sysCONFIG Port Timing – Corrected sysCONFIG SPI Port information.
		Pinout Information	Signal Descriptions – Modified info for VTT_x, PROBE_VCC, and PROBE_GND. Modified info for [LOC]_DLL[T,C]_IN[C,D,E,F].
		Supplemental Information	Updated list of technical notes, added reference to LatticeSC/M flexiPCS Data Sheet.
March 2008	02.0	DC and Switching Characteristics	Updated Internal Timing Parameters table.
			Updated Read Mode timing diagram.
			Updated Read Mode with Input Registers Only timing diagram.
June 2008	02.1	—	Data sheet status changed from preliminary to final.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
		DC and Switching Characteristics	Updated LatticeSC/M External Switching Characteristics table.
			Updated LatticeSC/M Internal Timing Parameters table.
			Removed Read-Before-Write sysMEM EBR mode.
December 2008	02.2	Architecture	Output/Tristate DDR/Shift Register Block Diagram - corrected connection to POS.
		DC and Switching Characteristics	DC and Switching Characteristics table - updated data for $t_{SUI\_PIO.}$
			Added $T_{R,}$ T_F parameter to PURESPEED I/O Differential Electrical Characteristics (LVDS) table.
		Multiple	Removed references to HyperTransport throughout the data sheet.
January 2010	02.3	Introduction	Updated per PCN #01A-10 (ceramic fcBGA conversion to organic fcBGA for the 1152-ball and 1704-ball fcBGA packages) and PCN #02A-10 (1020-ball organic fcBGA conversion to 1020-ball organic fcBGA revision 2 package).
		Ordering Information	

Date	Version	Section	Change Summary
December 2011	02.4	DC and Switching Characteristics	Updated JTAG Port Timing Specifications table.